

# TVS Diodes

Transient Voltage Suppressor Diodes

## ESD103-B1-02 Series

Bi-directional Femto Farad Capacitance TVS Diode

ESD103-B1-02ELS  
ESD103-B1-02EL

## Data Sheet

Revision 1.3, 2014-06-12  
Final

**Edition 2014-06-12**

**Published by**  
**Infineon Technologies AG**  
**81726 Munich, Germany**  
**© 2014 Infineon Technologies AG**  
**All Rights Reserved.**

#### **Legal Disclaimer**

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

#### **Information**

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office ([www.infineon.com](http://www.infineon.com))

#### **Warnings**

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

# 1 Bi-directional Femto Farad Capacitance TVS Diode

## 1.1 Features

- ESD/Transient protection of RF and ultra-high speed signal lines according to:
  - IEC61000-4-2:  $\pm 10$  kV (contact)
- Extremely low capacitance  $C_L = 0.09$  pF (typical) at  $f = 1$  GHz
- Maximum working voltage:  $V_{RWM} = \pm 15$  V
- Very low reverse current:  $I_R < 0.1$  nA (typ.)
- Very low series inductance down to 0.2 nH typical (TSSLP-2-4)
- Extremely small form factor down to  $0.62 \times 0.32 \times 0.31$  mm<sup>2</sup>
- Pb-free package (RoHS compliant)



## 1.2 Application Examples [4]

- ESD protection in RF applications
- Tailored for connectivity applications
- WLAN, GPS antenna, DVB T/H, Bluetooth Class 1 and 2
- Automated Meter Reading

## 1.3 Product Description

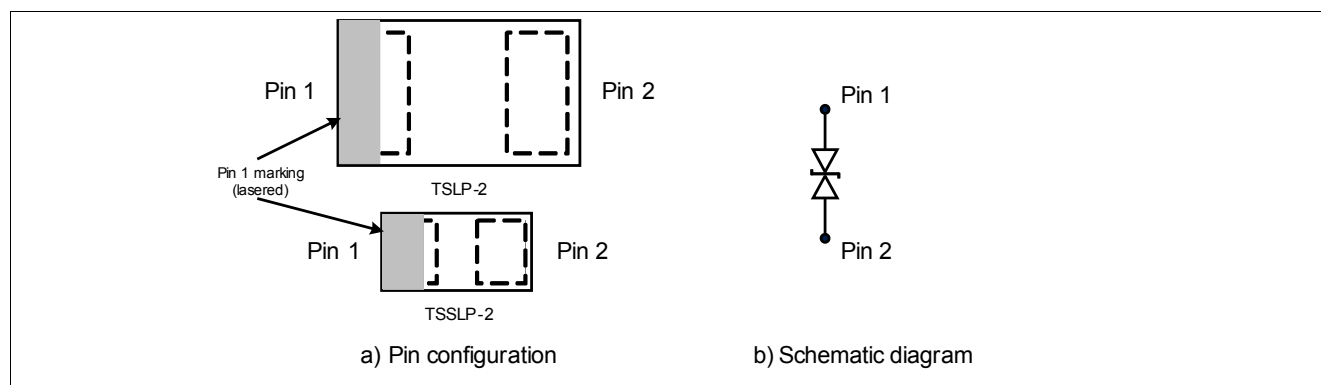


Figure 1 Pin configuration and Schematic diagram

Table 1 Ordering Information

| Type            | Package   | Configuration          | Marking code |
|-----------------|-----------|------------------------|--------------|
| ESD103-B1-02ELS | TSSLP-2-4 | 1 line, bi-directional | <u>V</u>     |
| ESD103-B1-02EL  | TSLP-2-20 | 1 line, bi-directional | V            |

## 2 Characteristics

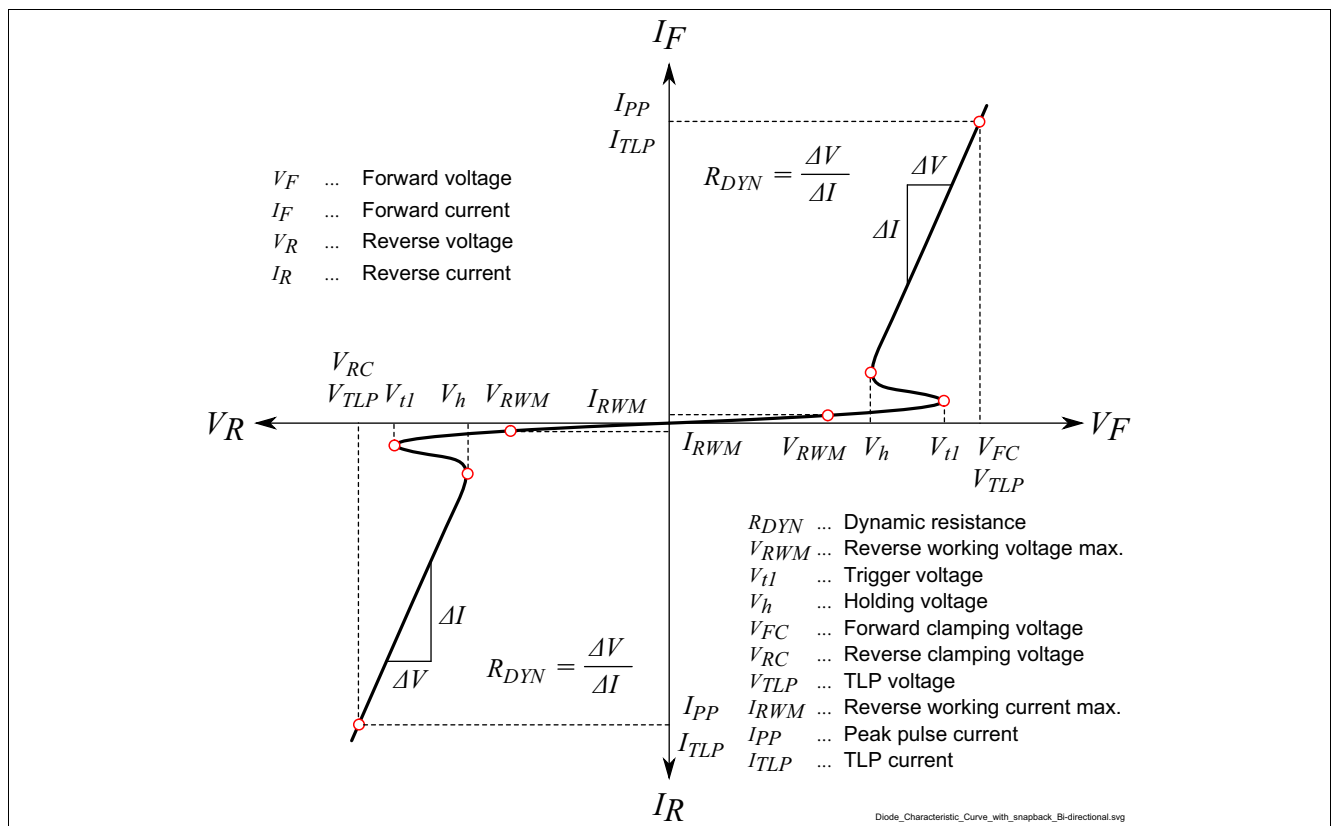
**Table 2** Maximum Ratings at  $T_A = 25\text{ °C}$ , unless otherwise specified

| Parameter                           | Symbol    | Values |      |      | Unit |
|-------------------------------------|-----------|--------|------|------|------|
|                                     |           | Min.   | Typ. | Max. |      |
| ESD contact discharge <sup>1)</sup> | $V_{ESD}$ | -10    | –    | 10   | kV   |
| Operating temperature               | $T_{OP}$  | -55    | –    | 125  | °C   |
| Storage temperature                 | $T_{stg}$ | -65    | –    | 150  | °C   |

1)  $V_{ESD}$  according to IEC61000-4-2 ( $R = 330\text{ }\Omega$ ,  $C = 150\text{ pF}$  discharge network)

**Attention:** Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.

### 2.1 Electrical Characteristics at $T_A = 25\text{ °C}$ , unless otherwise specified



**Figure 2** Definitions of electrical characteristics

## Characteristics

**Table 3** DC Characteristics at  $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

| Parameter               | Symbol     | Values |      |      | Unit | Note / Test Condition                        |
|-------------------------|------------|--------|------|------|------|----------------------------------------------|
|                         |            | Min.   | Typ. | Max. |      |                                              |
| Reverse working voltage | $V_{RWM}$  | -15    | –    | 15   | V    |                                              |
| Trigger voltage         | $V_{Trig}$ | –      | 21   | –    | V    | $I_{BR} = 1\text{ mA}$ , from Pin 1 to Pin 2 |
|                         |            | –      | 21   | –    |      | $I_{BR} = 1\text{ mA}$ , from Pin 2 to Pin 1 |
| Reverse current         | $I_R$      | –      | <0.1 | 50   | nA   | $V_R = 15\text{ V}$                          |

**Table 4** RF Characteristics at  $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

| Parameter         | Symbol | Values |      |      | Unit | Note / Test Condition                   |
|-------------------|--------|--------|------|------|------|-----------------------------------------|
|                   |        | Min.   | Typ. | Max. |      |                                         |
| Line capacitance  | $C_L$  | –      | 0.13 | 0.2  | pF   | $V_R = 0\text{ V}$ , $f = 1\text{ MHz}$ |
|                   |        | –      | 0.09 | –    |      | $V_R = 0\text{ V}$ , $f = 1\text{ GHz}$ |
| Series inductance | $L_S$  | –      | 0.2  | –    | nH   | ESD103-B1-02ELS<br>ESD103-B1-02EL       |
|                   |        | –      | 0.4  | –    |      |                                         |

**Table 5** ESD Characteristics at  $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

| Parameter                        | Symbol    | Values |      |      | Unit     | Note / Test Condition   |
|----------------------------------|-----------|--------|------|------|----------|-------------------------|
|                                  |           | Min.   | Typ. | Max. |          |                         |
| Clamping voltage <sup>1)</sup>   | $V_{CL}$  | –      | 20   | –    | V        | $I_{TLP} = 1\text{ A}$  |
|                                  |           | –      | 36   | –    |          | $I_{TLP} = 8\text{ A}$  |
|                                  |           | –      | 48   | –    |          | $I_{TLP} = 16\text{ A}$ |
| Dynamic resistance <sup>1)</sup> | $R_{DYN}$ | –      | 1.8  | –    | $\Omega$ | $t_p = 100\text{ ns}$   |

1) ANSI/ESD STM5.5.1 - Electrostatic Discharge Sensitive Testing using Transmission Line Pulse (TLP) Model. TLP conditions:  $Z_0 = 50\text{ }\Omega$ ,  $t_p = 100\text{ ns}$ ,  $t_r = 0.6\text{ ns}$ ,  $I_{TLP}$  and  $V_{TLP}$  averaging window:  $t_1 = 30\text{ ns}$  to  $t_2 = 60\text{ ns}$ , extraction of dynamic resistance using least squares fit of TLP characteristic between  $I_{TLP1} = 2\text{ A}$  and  $I_{TLP2} = 14.1\text{ A}$ . Please refer to Application Note AN210[1].

### 3 Typical Characteristics

At  $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

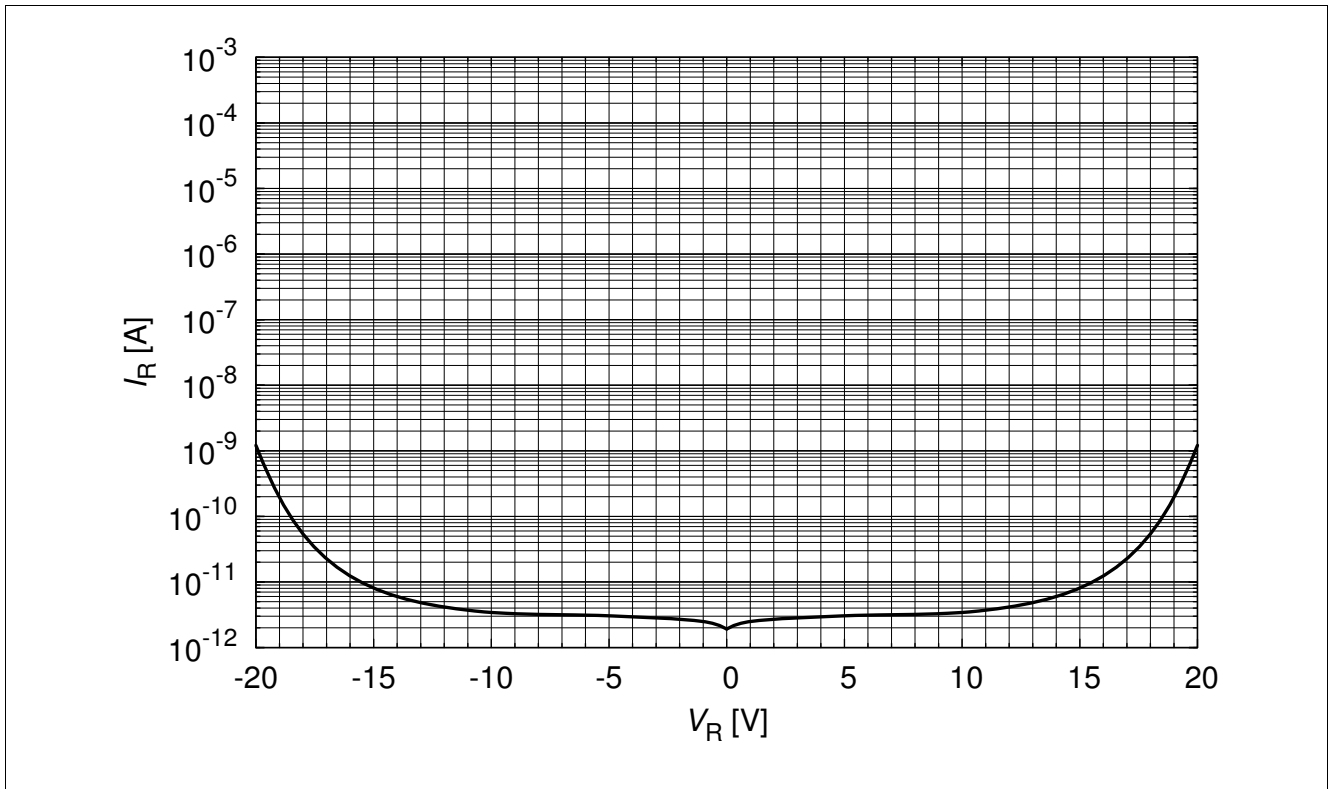


Figure 3 Reverse current  $I_R = f(V_R)$

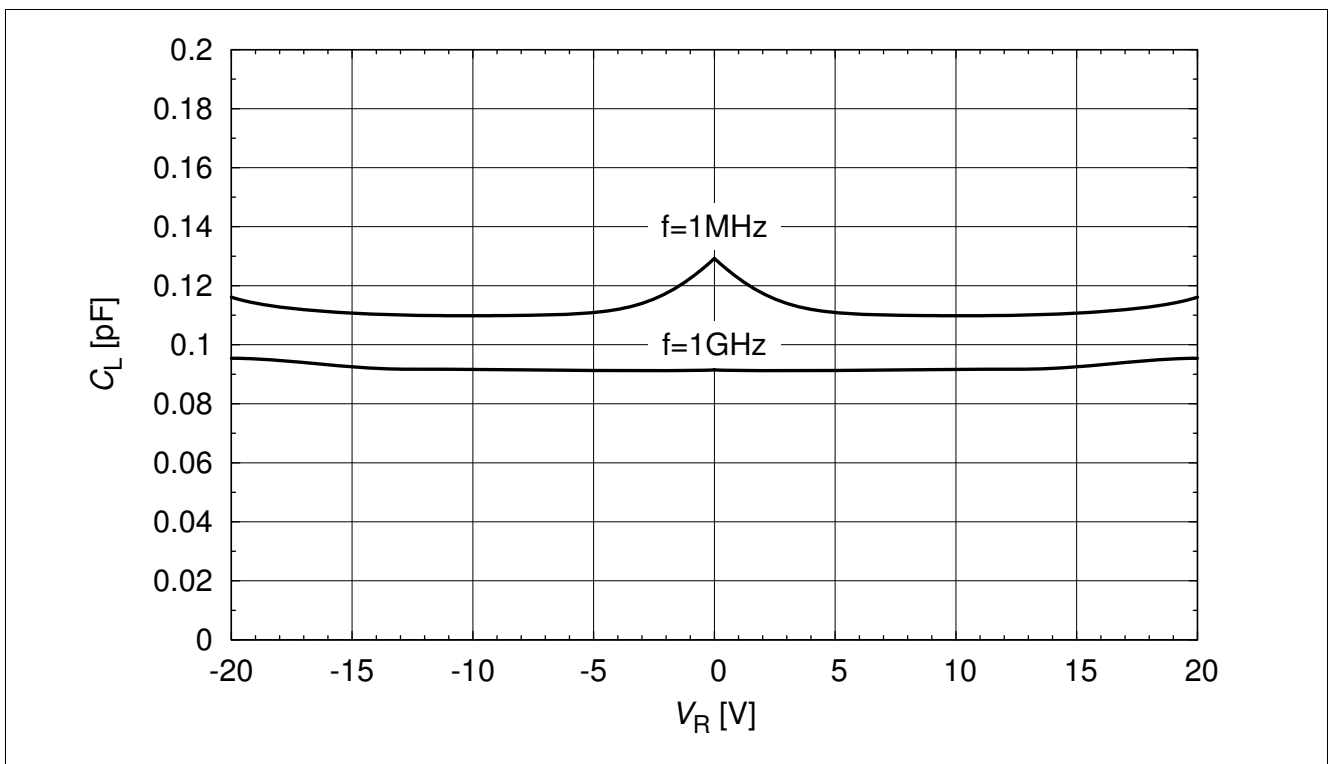


Figure 4 Line capacitance  $C_L = f(V_R)$ ,  $f = 1\text{ MHz}$

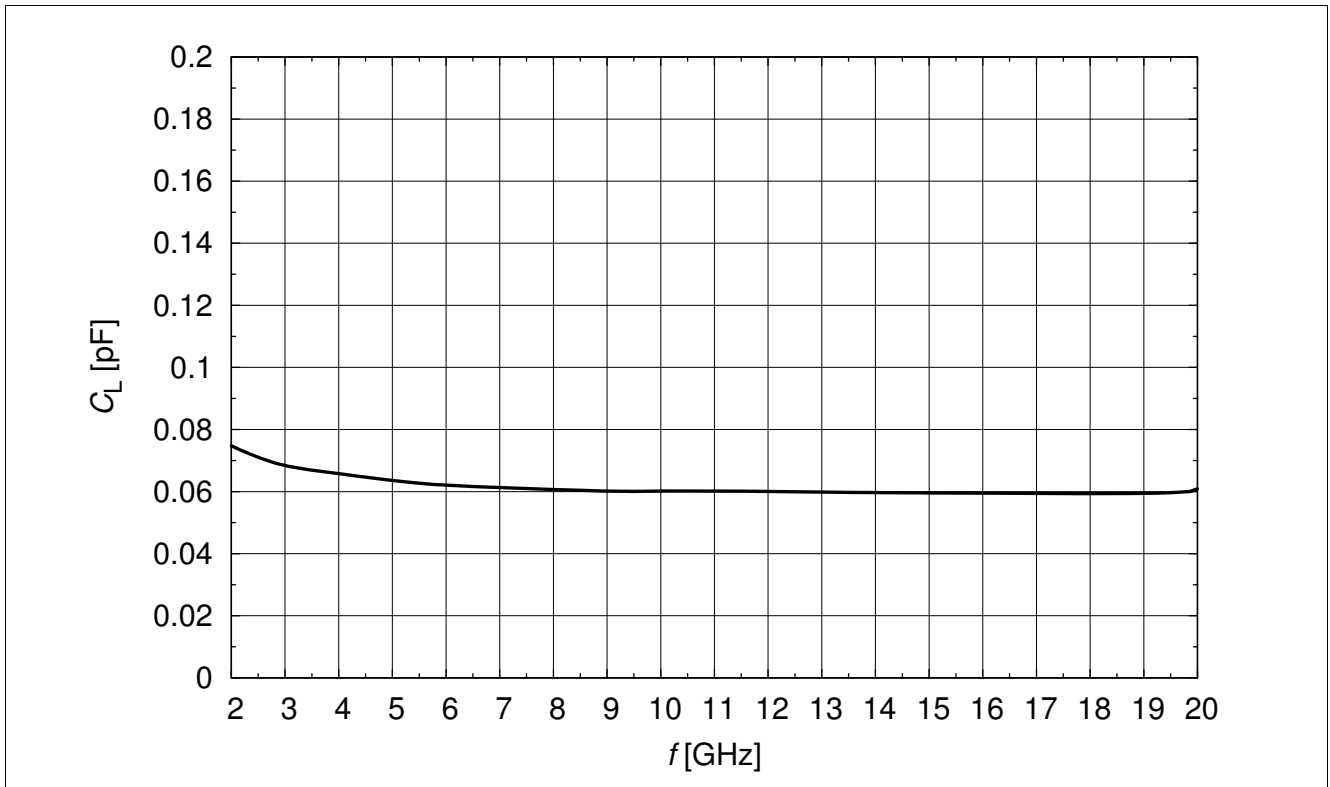
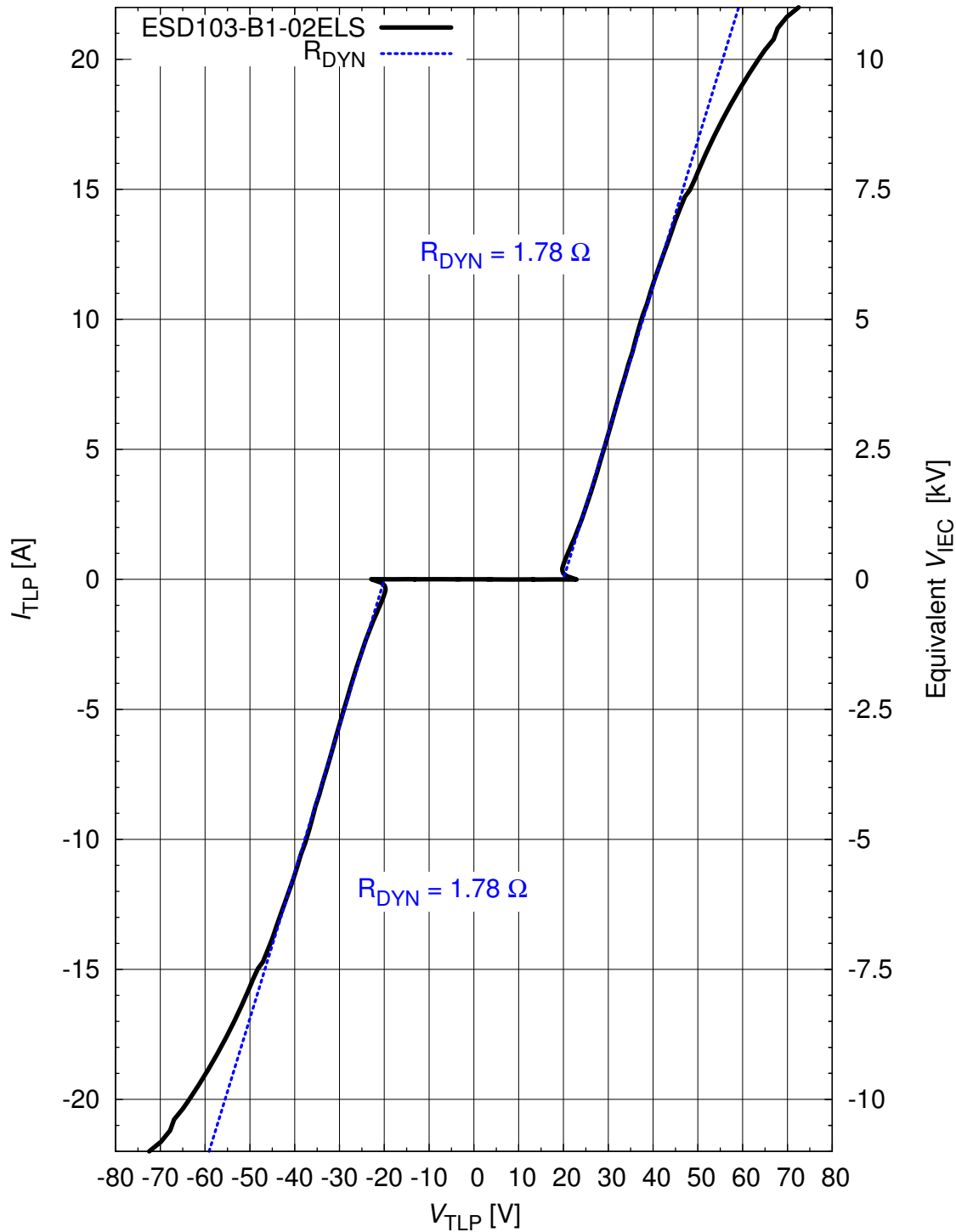


Figure 5 Line capacitance:  $C_L = f(f)$ ,  $V_R = 0$  V



**Figure 6** Clamping voltage (TLP):  $I_{TLP} = f(V_{TLP})$  according ANSI/ESDSTM5.5.1-Electrostatic Discharge Sensitivity Testing using Transmission Line Pulse (TLP) Model. TLP conditions:  $Z_0 = 50 \Omega$ ,  $t_p = 100$  ns,  $t_r = 0.6$  ns,  $I_{TLP}$  and  $V_{TLP}$  average window:  $t_1 = 30$  ns to  $t_2 = 60$  ns, extraction of dynamic resistance using squares fit to TLP characteristics between  $I_{TLP1} = 2$  A and  $I_{TLP2} = 14.1$  A. Please refer to Application Note AN210[1]



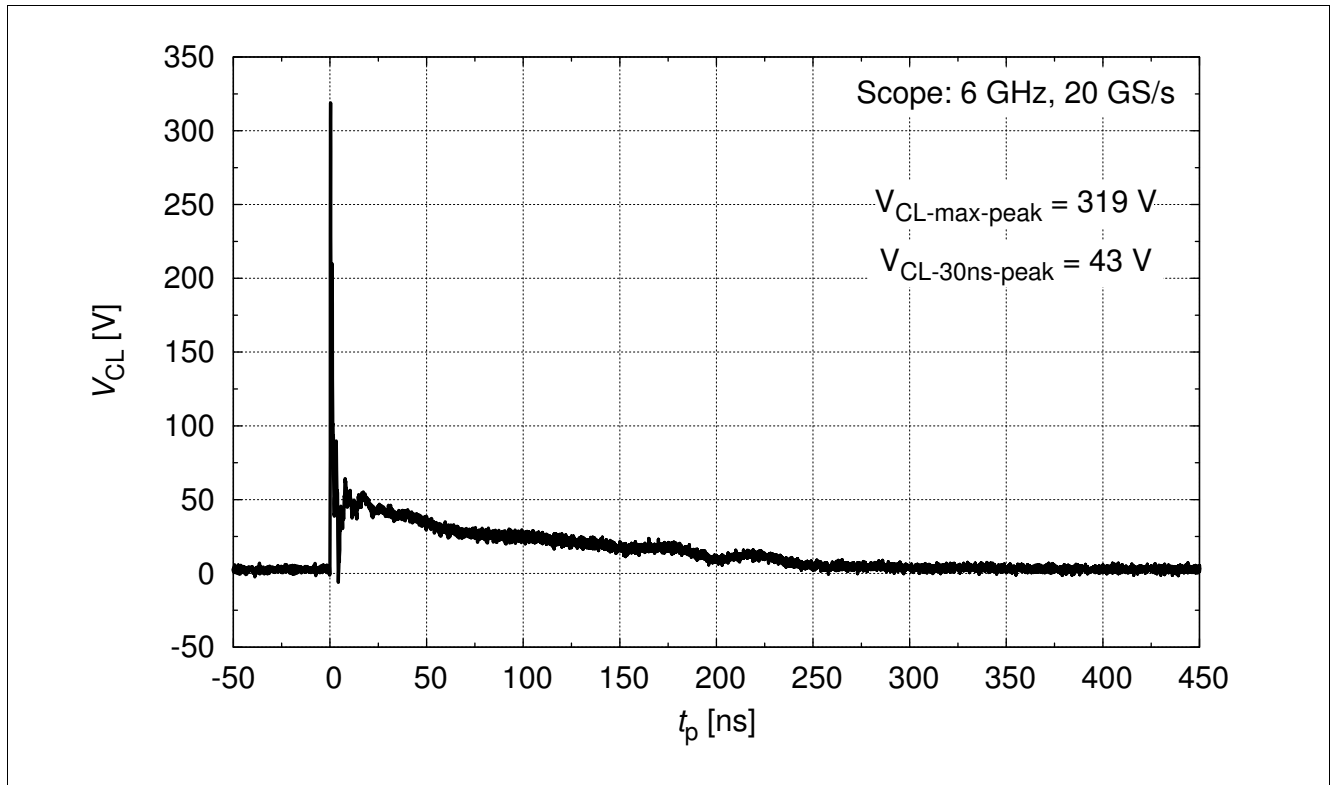


Figure 7 Clamping voltage at +8 kV discharge according IEC61000-4-2 ( $R = 330 \, \Omega$ ,  $C = 150 \text{ pF}$ )

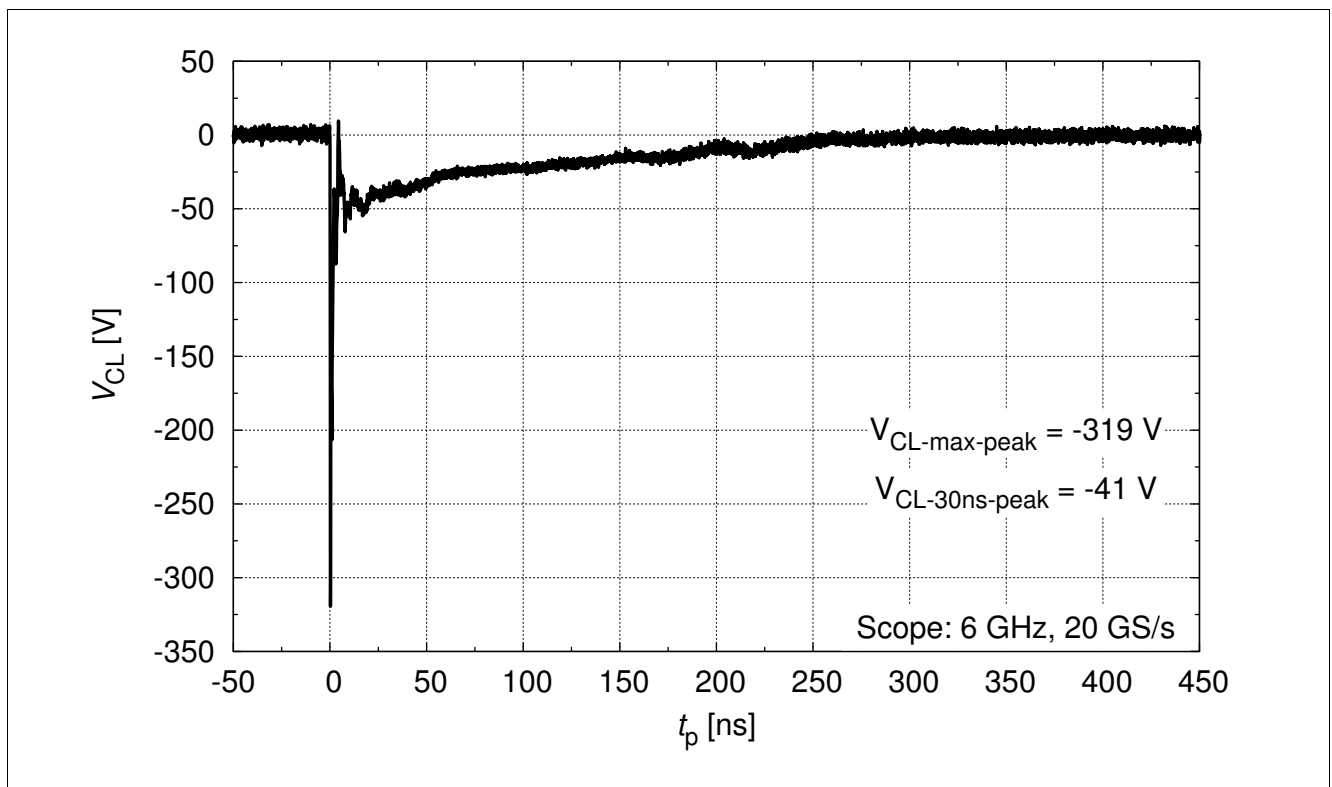


Figure 8 Clamping voltage at -8 kV discharge according IEC61000-4-2 ( $R = 330 \, \Omega$ ,  $C = 150 \text{ pF}$ )

## 4 Package Information

### 4.1 TSSLP-2-4 [2]

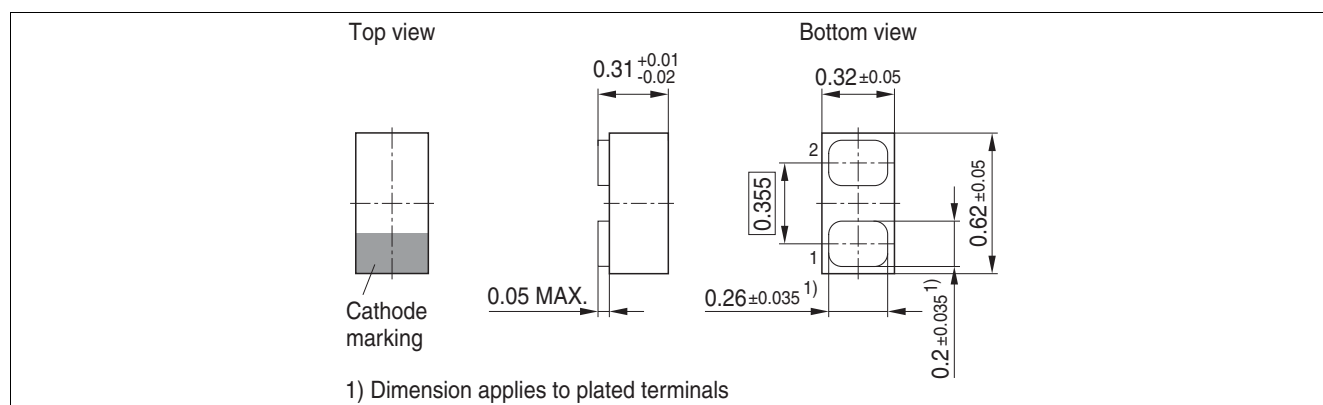


Figure 9 TSSLP-2-4 Package outline

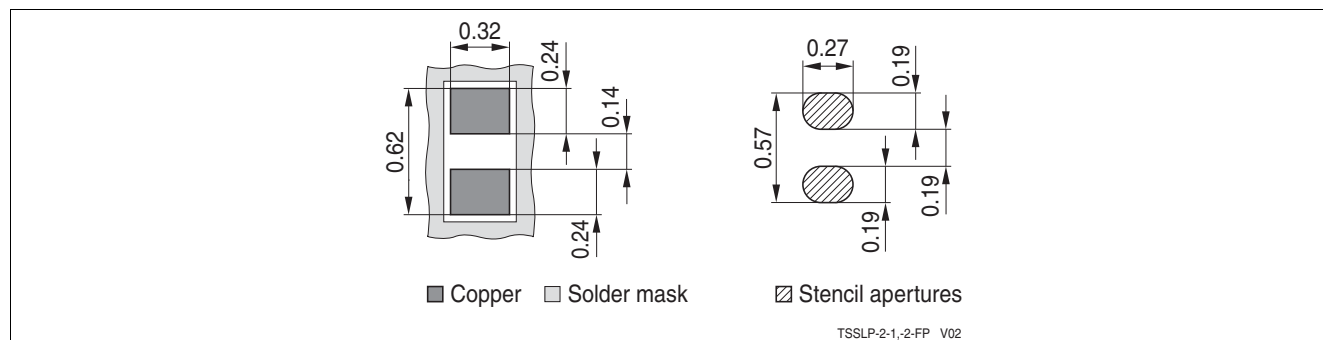


Figure 10 TSSLP-2-4 Footprint

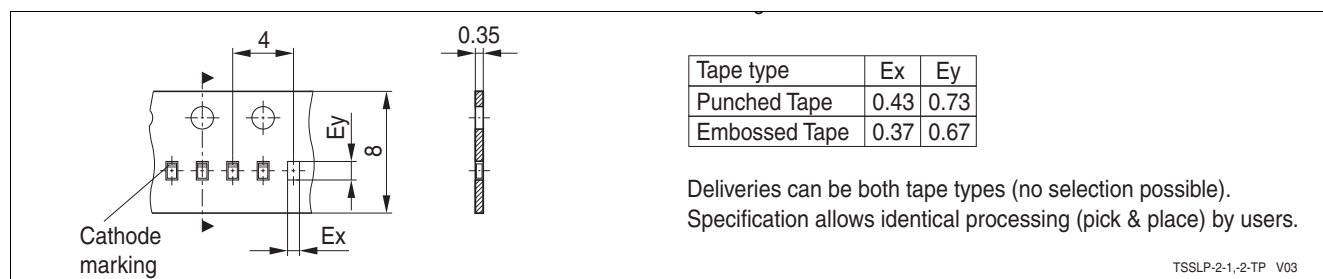


Figure 11 TSSLP-2-4 Packing

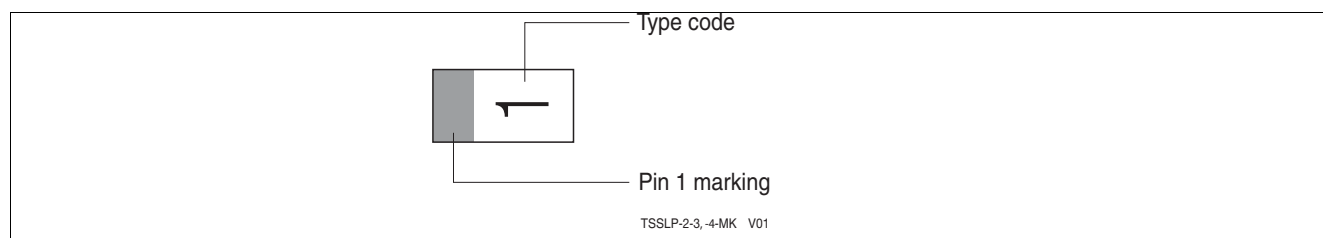


Figure 12 TSSLP-2-4 Marking (example)

## 4.2 TSLP-2-20 [2]

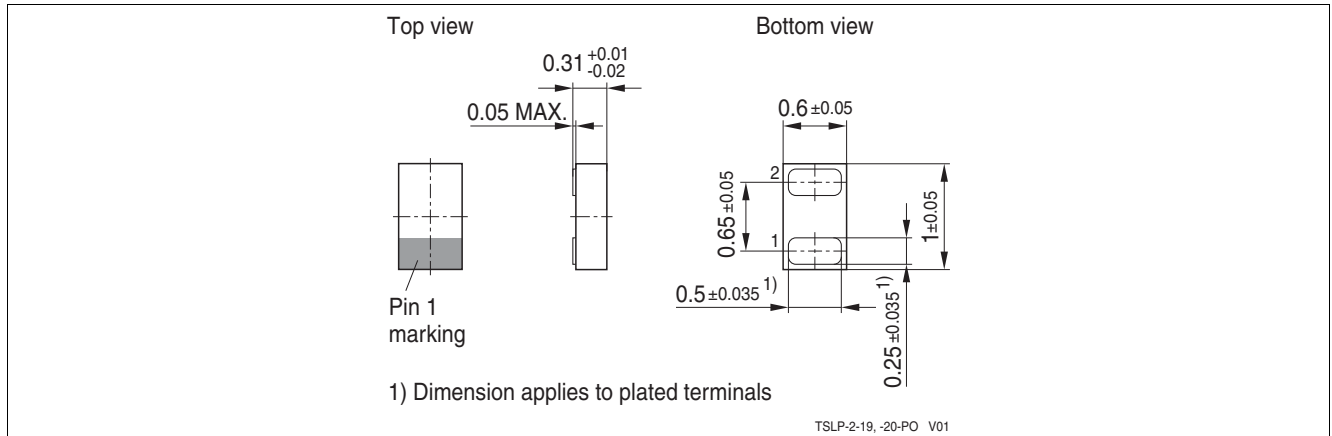


Figure 13 TSLP-2-20 Package outline

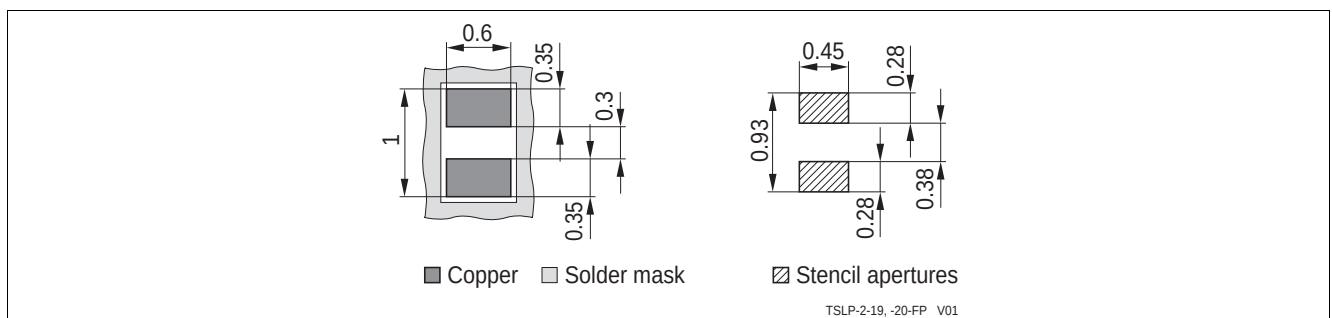


Figure 14 TSLP-2-20 Footprint

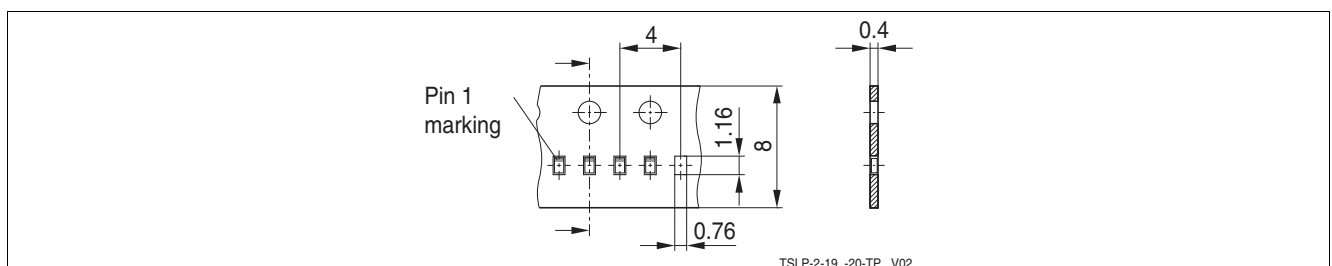


Figure 15 TSLP-2-20 Packing

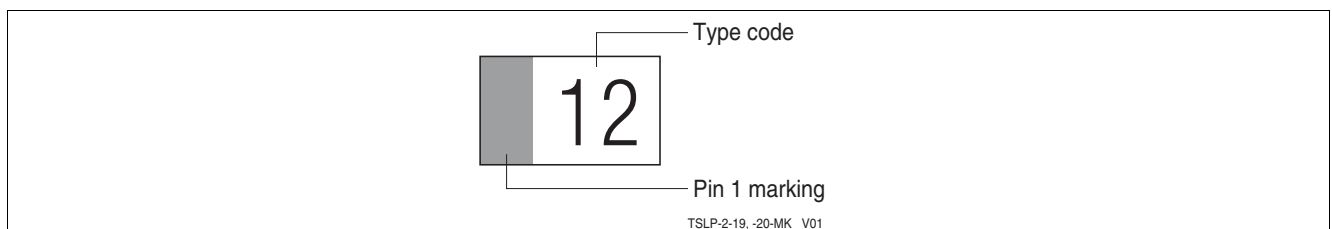


Figure 16 TSLP-2-20 Marking (example)

## References

- [1] Infineon AG - **Application Note AN210**: Effective ESD Protection Design at System Level using VF-TLP Characterization Methodology
- [2] Infineon AG - Recommendations for PCB Assembly of Infineon TSLP and TSSLP Packages
- [3] Tero, Ranta, Juha Ellä, Helena Pohjonen: Antenna Switch Linearity Requirements for GSM/WCDMA Mobile Phone Front-Ends. Nokia Technology Platforms, P.O.Box 86, FIN-24101 SALO.
- [4] Infineon AC - Application Note AN327: ESD101-B1 / ESD103-B1, Bi-directional Ultra Low Capacitance Transient Voltage Suppression Diodes for High Power RF Applications.

**Revision History: Revision 1.2, 2013-07-22**

| Page or Item | Subjects (major changes since previous revision) |
|--------------|--------------------------------------------------|
|--------------|--------------------------------------------------|

**Revision 1.3, 2014-06-12**

|   |                  |
|---|------------------|
| 6 | Table 5) updated |
|   |                  |
|   |                  |
|   |                  |
|   |                  |

**Trademarks of Infineon Technologies AG**

AURIX™, BlueMoon™, COMNEON™, C166™, CROSSAVE™, CanPAK™, CIPOS™, CoolMOS™, CoolSET™, CORECONTROL™, DAVE™, EasyPIM™, EconoBRIDGE™, EconoDUAL™, EconoPACK™, EconoPIM™, EiceDRIVER™, EUPEC™, FCOS™, HITFET™, HybridPACK™, ISOFACE™, I<sup>2</sup>RF™, IsoPACK™, MIPAQ™, ModSTACK™, my-d™, NovalithIC™, OmniTune™, OptiMOS™, ORIGA™, PROFET™, PRO-SIL™, PRIMARION™, PrimePACK™, RASIC™, ReverSave™, SatRIC™, SIEGET™, SINDRION™, SMARTi™, SmartLEWIS™, TEMPFET™, thinQ!™, TriCore™, TRENCHSTOP™, X-GOLD™, XMM™, X-PMU™, XPOSYS™.

**Other Trademarks**

Advance Design System™ (ADS) of Agilent Technologies, AMBA™, ARM™, MULTI-ICE™, PRIMECELL™, REALVIEW™, THUMB™ of ARM Limited, UK. AUTOSAR™ is licensed by AUTOSAR development partnership. Bluetooth™ of Bluetooth SIG Inc. CAT-iq™ of DECT Forum. COLOSSUS™, FirstGPS™ of Trimble Navigation Ltd. EMV™ of EMVCo, LLC (Visa Holdings Inc.). EPCOS™ of Epcos AG. FLEXGO™ of Microsoft Corporation. FlexRay™ is licensed by FlexRay Consortium. HYPERTERMINAL™ of Hilgraeve Incorporated. IEC™ of Commission Electrotechnique Internationale. IrDA™ of Infrared Data Association Corporation. ISO™ of INTERNATIONAL ORGANIZATION FOR STANDARDIZATION. MATLAB™ of MathWorks, Inc. MAXIM™ of Maxim Integrated Products, Inc. MICROTEC™, NUCLEUS™ of Mentor Graphics Corporation. Mifare™ of NXP. MIPI™ of MIPI Alliance, Inc. MIPS™ of MIPS Technologies, Inc., USA. muRata™ of MURATA MANUFACTURING CO., MICROWAVE OFFICE™ (MWO) of Applied Wave Research Inc., OmniVision™ of OmniVision Technologies, Inc. Openwave™ Openwave Systems Inc. RED HAT™ Red Hat, Inc. RFMD™ RF Micro Devices, Inc. SIRIUS™ of Sirius Sattelite Radio Inc. SOLARIS™ of Sun Microsystems, Inc. SPANSION™ of Spansion LLC Ltd. Symbian™ of Symbian Software Limited. TAIYO YUDEN™ of Taiyo Yuden Co. TEAKLITE™ of CEVA, Inc. TEKTRONIX™ of Tektronix Inc. TOKO™ of TOKO KABUSHIKI KAISHA TA. UNIX™ of X/Open Company Limited. VERILOG™, PALLADIUM™ of Cadence Design Systems, Inc. VLYNQ™ of Texas Instruments Incorporated. VXWORKS™, WIND RIVER™ of WIND RIVER SYSTEMS, INC. ZETEX™ of Diodes Zetex Limited.

Last Trademarks Update 2010-06-09

[www.infineon.com](http://www.infineon.com)

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Infineon:](#)

[ESD103B102ELSE6327XTSA1](#) [ESD103B102ELE6327XTMA1](#) [ESD103-B1-02ELS E6327](#) [ESD103-B1-02EL E6327](#)